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Product data sheet

1. General description

Planar Low V_F Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- · Very low forward voltage
- High power capability due to clip-bonding technology
- · Small and thin SMD plastic package

3. Applications

- High efficiency DC-to-DC conversion
- Low voltage rectification
- · Switch mode power supply
- · Freewheeling application
- · Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--------------------|-------------------------|--|-----|-----|-----|-----|------|
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 174 °C | | - | - | 5 | Α |
| V _R | reverse voltage | T _j = 25 °C | | - | - | 60 | V |
| V _F | forward voltage | I _F = 5 A; pulsed; T _j = 25 °C | [1] | - | 480 | 560 | mV |
| I _R | reverse current | $V_R = 60 \text{ V}$; pulsed; $T_j = 25 ^{\circ}\text{C}$ | [1] | - | 100 | 400 | μΑ |

^[1] Very short pulse, in order to maintain a stable junction temperature.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--------------------|----------------|
| 1 | Α | anode | 5 | |
| 2 | Α | anode | | K A |
| 3 | K | cathode | | aaa-009063 |
| | | | CFP15B (SOT1289B) | |



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6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | |
|----------------|---------|--|----------|--|--|--|
| | Name | Description | Version | | | |
| PMEG060V050EPE | | plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body | SOT1289B | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|----------------|--------------|
| PMEG060V050EPE | 060V 050E |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|-------------------------------------|---|-----|-----|------|------|
| V _R | reverse voltage | T _j = 25 °C | | - | 60 | V |
| l _F | forward current | δ = 1; T _{sp} ≤ 173 °C | | - | 7 | Α |
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 174 °C | | - | 5 | А |
| I _{FSM} | non-repetitive peak forward current | half sine-wave pulse; t_p = 8.3 ms; $T_{j(init)}$ = 25 °C | | - | 160 | А |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [1] | - | 1.66 | W |
| | | | [2] | - | 2.15 | W |
| Tj | junction temperature | | | - | 175 | °C |
| T _{amb} | ambient temperature | | | -55 | 175 | °C |
| T _{stg} | storage temperature | | | -65 | 175 | °C |

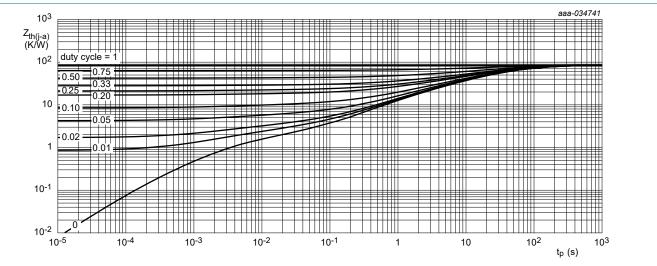
- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

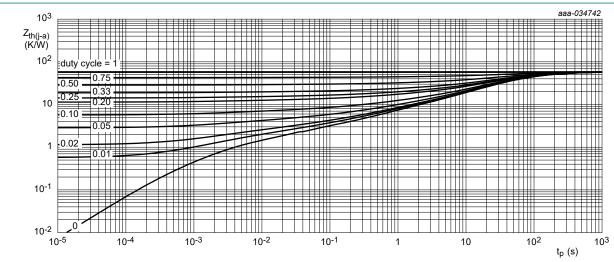
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-----------------------|--|-------------|---------|-----|-----|-----|------|
| R _{th(j-a)} | thermal resistance from | in free air | [1] [2] | - | - | 90 | K/W |
| | junction to ambient | | [1] [3] | - | - | 70 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | [4] | - | - | 3 | K/W |

- For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- Soldering point of cathode tab.



FR4 PCB, standard footprint

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values Fig. 1.



FR4 PCB, mounting pad for cathode 1 cm²

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

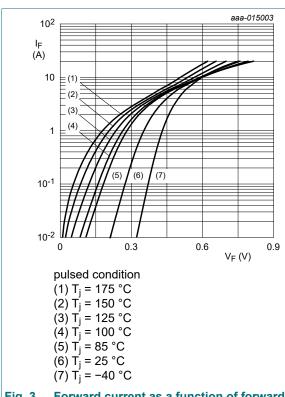
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10. Characteristics

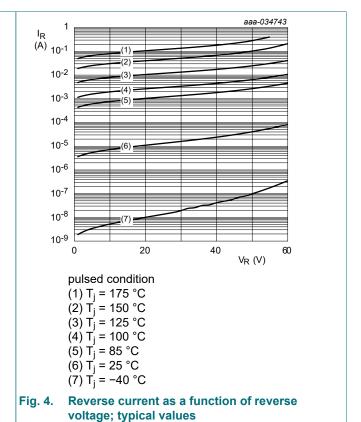
Table 7 Characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--------------------|-------------------------------------|--|-----|-----|-----|-----|------|
| V _{(BR)R} | reverse breakdown voltage | $I_R = 5 \text{ mA}$; pulsed; $T_j = 25 \text{ °C}$ | [1] | 60 | - | - | V |
| V _F | forward voltage | I _F = 1 A; pulsed; T _j = 25 °C | [1] | - | 350 | 400 | mV |
| | | I _F = 5 A; pulsed; T _j = 25 °C | [1] | - | 480 | 560 | mV |
| | | I _F = 5 A; pulsed; T _j = -40 °C | [1] | - | 530 | 620 | mV |
| | | I _F = 5 A; pulsed; T _j = 125 °C | [1] | - | 445 | 540 | mV |
| I _R | reverse current | V _R = 60 V; pulsed; T _j = 25 °C | [1] | - | 100 | 400 | μΑ |
| C _d d | diode capacitance | V _R = 1 V; f = 1 MHz; T _j = 25 °C | | - | 429 | - | pF |
| | | V _R = 10 V; f = 1 MHz; T _j = 25 °C | | - | 148 | - | pF |
| t _{rr} | reverse recovery time step recovery | $I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$ | | - | 14 | - | ns |
| | reverse recovery time ramp recovery | $dI_F/dt = 100 \text{ A/}\mu\text{s}; I_F = 3 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 \text{ °C}$ | | - | 12 | - | ns |
| V_{FRM} | peak forward recovery voltage | $I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/µs}; T_j = 25 °C$ | | - | 340 | - | mV |

[1] Very short pulse, in order to maintain a stable junction temperature.



Forward current as a function of forward Fig. 3. voltage; typical values



400

200

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60

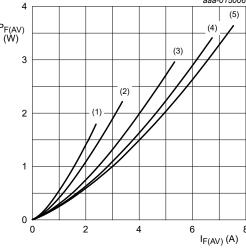
V_R (V)

f = 1 MHz; T_{amb} = 25 °C

20

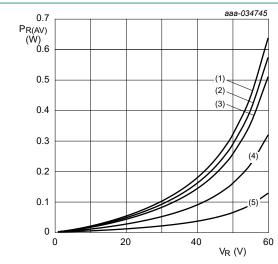
Fig. 5. Diode capacitance as a function of reverse voltage; typical values

40



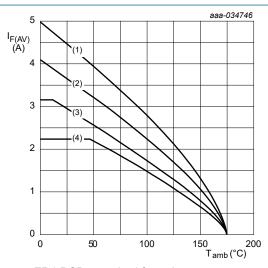
 $T_j = 100 \,^{\circ}\text{C}$ $(1) \, \delta = 0.1$ $(2) \, \delta = 0.2$ $(3) \, \delta = 0.5$ $(4) \, \delta = 0.8$ $(5) \, \delta = 1$

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 100 \,^{\circ}\text{C}$ $(1) \, \delta = 1$ $(2) \, \delta = 0.9$ $(3) \, \delta = 0.8$ $(4) \, \delta = 0.5$ $(5) \, \delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values

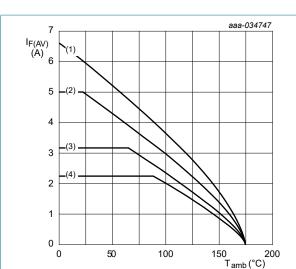


FR4 PCB, standard footprint $T_j = 175$ °C (1) $\delta = 1$; DC (2) $\delta = 0.5$; f = 20 kHz (3) $\delta = 0.2$; f = 20 kHz (4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values

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FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

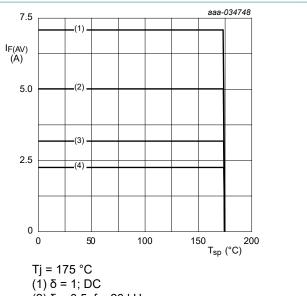
 $(1) \delta = 1; DC$

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



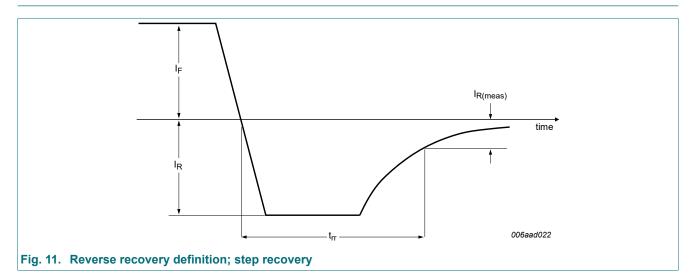
(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information



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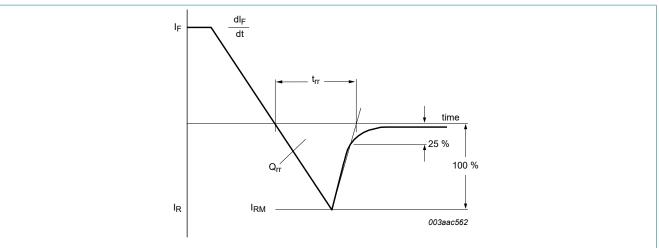


Fig. 12. Reverse recovery definition; ramp recovery

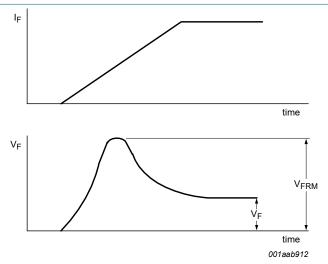


Fig. 13. Forward recovery definition

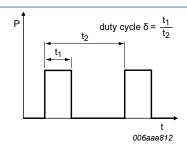


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

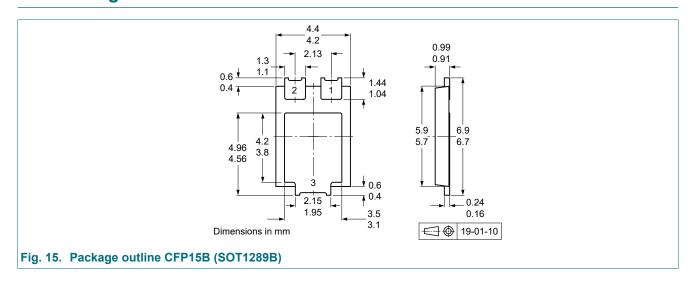
 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_{M} \times \sqrt{\delta}$

with $I_{\mbox{\scriptsize RMS}}$ defined as RMS current.

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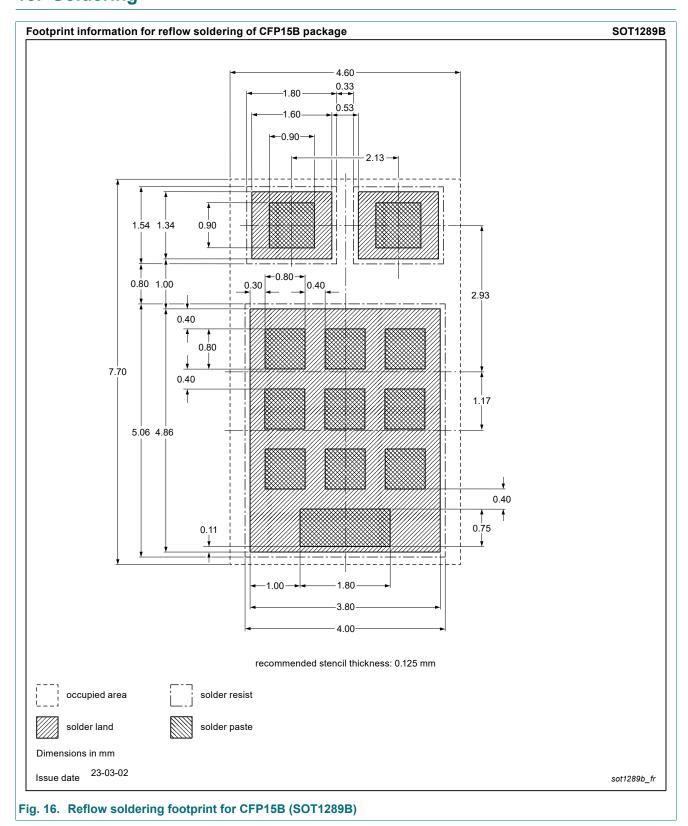
12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history

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|--|---------------|----------------------------|----------------|-----------------------------|--|--|--|--|
| Data sheet ID | Release date | | Change notice | Supersedes | | | | |
| PMEG060V050EPE v.2 | 20240715 | Product data sheet | - | PMEG060V050EPE v.1 | | | | |
| Modifications: | Reflow solder | ring footprint: Stencil de | esign for solo | der paste printing changed. | | | | |
| PMEG060V050EPE v.1 | 20220719 | Product data sheet | - | - | | | | |

15. Legal information

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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